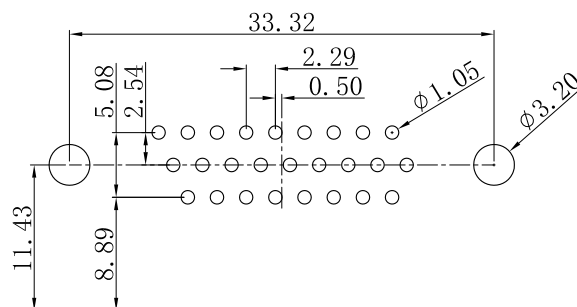
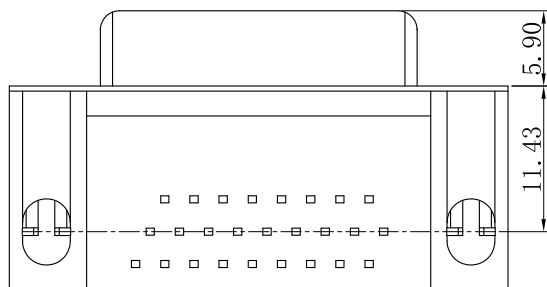
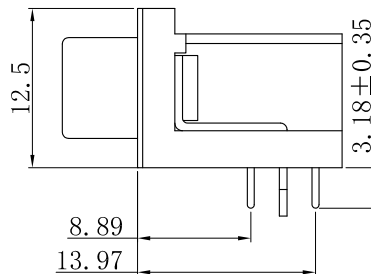
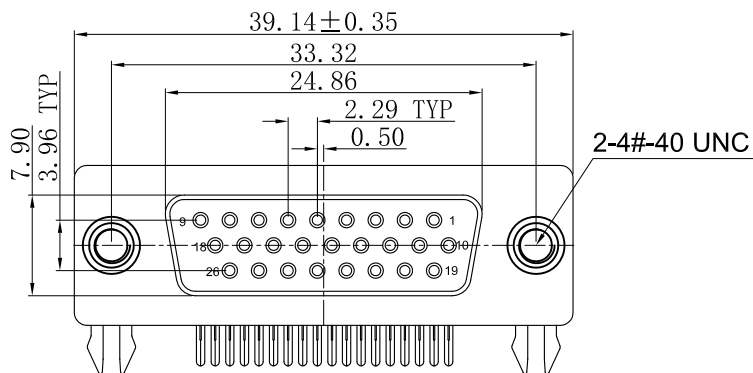


The product using material and processing must conform to the "WI-PZ-142" HSF technical standard control requirements



PCB layout

Note:

1. Specification:

- 1.1 Rated voltage: 125V
- 1.2 Rated current: 3A
- 1.3 Contact Resistance: 30m ohms Max.
- 1.4 Insulation Resistance: 1000M ohms Min. at 500V/DC for 1Minute.
- 1.5 Withstanding voltage: 500VAC/minute
- 1.6 operation temperature: $-55^{\circ}\text{C} \sim 105^{\circ}\text{C}$

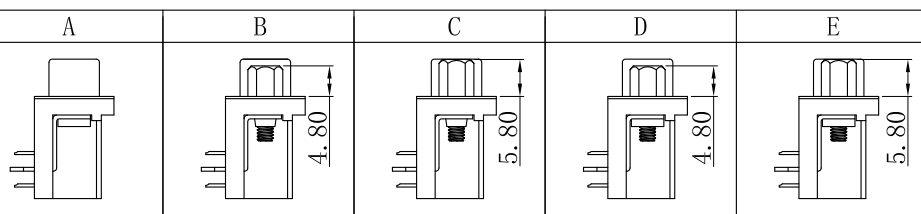
2. Material:

- 2.1 housing: PBT+30% Black/Blue; UL94V-0
- 2.4 Contact: C2680, Plating 0.6u" Plated on Contact Area, 80u" Min. Tin Plated on Solder Tails Area, 30u" Min. Nickel Underplating Over All.
- 2.5 Shell: SPCC, Plating 80u" Min. Nickel Underplating Over All.

WLDBF9-26 1 X X X 01-024

PLATING: 1—G/F
2—AU 3U"
5—AU 15U"
6—AU 30U"
Specification
Colour: A:Black
K:White

Specification Type (1:2)



REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO:	DWG.NO:	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13	WLDBF9-261XXX01-024	ENDE05	
			0.0±0.35	X'REF±6'	DESIGNER	Ding_bo	21.01.13	TITLE:			
			UNIT: mm	0.00±0.25	X'±3'	DRAWN	Ou_jian	21.01.13	HDR 26P/F 8.89 系列		
			SIZE: A4	0.000±0.10	X'X' ±2'					REV: A0	SHEET: 1/1